

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field Device Integration (FDI) –
Part 101-1: Profiles – Foundation Fieldbus H1**

**Intégration des appareils de terrain (FDI) –
Partie 101-1: Profils – Foundation Fieldbus H1**





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FIELD DEVICE INTEGRATION (FDI) –

Part 101-1: Profiles – Foundation Fieldbus H1

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/352/CDV	65E/415/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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FIELD DEVICE INTEGRATION (FDI) –

Part 101-1: Profiles – Foundation Fieldbus H1

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-1_CP 1/1 (FOUNDATION™ Fieldbus H1)¹.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61158-5-9:2014, *Industrial communication networks - Fieldbus specifications - Part 5-9: Application layer service definition - Type 9 elements*

IEC 61784-1, *Industrial communication networks - Profiles - Part 1: Fieldbus profiles*

IEC 61784-2, *Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3*

IEC 61784-3:2010, *Industrial communication networks - Profiles - Part 3: Functional safety fieldbuses - General rules and profile definitions*

IEC 61804 (all parts), *Function blocks (FB) for process control*

IEC 62541-100:2015, *OPC Unified Architecture – Part 100: OPC UA for Devices*

NOTE IEC 62769-1 is technically identical to FDI-2021.

IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*

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IEC 62769-4:2015, *Field Device Integration (FDI) – Part 4: FDI Packages*

NOTE IEC 62769-4 is technically identical to FDI-2024.

IEC 62769-5:2015, *Field Device Integration (FDI) – Part 5: FDI Information Model*

NOTE IEC 62769-5 is technically identical to FDI-2025.

IEC 62769-6, *Field Device Integration (FDI) – Part 6: FDI Technology Mapping*

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